DECLARATION FOR PATENT APPLICATION

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name. I believe I am an original, first and joint inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled: **ON-CHIP SUBSTRATE REGULATOR TEST MODE.** The specification of which (check one) _x_ is attached hereto or __ was filed on as Application Serial No. and was amended on (if applicable). I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, Section 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)			Priority Claim	
			Yes	No
Number	Country	Day/Month/Year Filed		

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Application Serial No.	Filing Date	Status: Patented, Pending, Abandoned

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full Name of Inventor: Gary Gilliam

Inventor's Signature: Gary Gilliam 8-16-95
Date

Residence: 6410 Randolph Drive, Boise, Idaho 83709
Citizenship: USA
Post Office Address: 8000 S. Federal Way, Boise, Idaho 83706

PATENT
Attorney Docket No.: **MICRON-01023**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:	)	Group:
	)	Art Unit:
Gary Gilliam	)	Examiner:
	)	
Serial No.:	)	
	)	
Filed: Filed Herewith	)	**POWER OF ATTORNEY BY ASSIGNEE**
	)	
For: **ON-CHIP SUBSTRATE REGULATOR TEST MODE**	)	

Honorable Commissioner of Patents and Trademarks
Washington, D.C. 20231

Sir:

MICRON TECHNOLOGY, INC., Assignee of the above-identified application by Assignment dated 08/16/95 hereby appoints Lia M. Pappas,(Reg. No. 34,095) and also the members of the firm of HAVERSTOCK & ASSOCIATES a firm including Thomas B. Haverstock (Reg. No. 32,571) and Jonathan O. Owens (Reg. No. 37,902), 260 Sheridan Avenue, Suite 420, Palo Alto, California 94306, (415) 833-0160, as its attorneys with full power of substitution to prosecute this application and to transact all business in the Patent and Trademark Office in connection therewith.

Please direct all correspondence regarding this application to the following:

Thomas B. Haverstock
HAVERSTOCK & ASSOCIATES
260 Sheridan Avenue, Suite 420
Palo Alto, California 94306
Telephone: (415) 833-0160
Facsimile: (415) 833-0170

I hereby certify that the Assignment document filed with the application or filed subsequent to the filing date of the application, has been reviewed and I hereby certify that, to the best of my knowledge and belief, title is with MICRON TECHNOLOGY, INC.

MICRON TECHNOLOGY, INC.

Dated: August 29, 1995

By: W. Bryan Farney
Name: W. Bryan Farney
Title: Vice President of Legal Affairs and General Counsel